LM709 Operational Amplifier

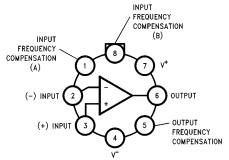
General Description

The LM709 series is a monolithic operational amplifier intended for general-purpose applications. Operation is completely specified over the range of voltages commonly used for these devices. The design, in addition to providing high gain, minimizes both offset voltage and bias currents. Further, the class-B output stage gives a large output capability with minimum power drain.

External components are used to frequency compensate the amplifier. Although the unity-gain compensation network specified will make the amplifier unconditionally stable in all feedback configurations, compensation can be tailored to optimize high-frequency performance for any gain setting. The LM709C is the commercial-industrial version of the LM709. It is identical to the LM709 except that it is specified for operation from 0°C to $+70^{\circ}\mathrm{C}$.

Connection Diagrams

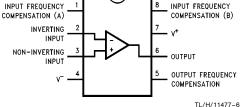
Metal Can Package



TL/H/11477-4

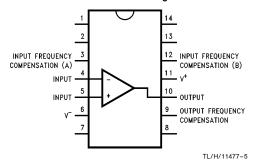
Order Number LM709AH, LM709H or LM709CH See NS Package Number H08C

Dual-In-Line Package NCY 1 8 INPUT FREQUENCY COMPENSATION (B)



Order Number LM709CN-8 See NS Package Number N08E

Dual-In-Line Package



Order Number LM709CN See NS Package Number N14A

Absolute Maximum Ratings (Note 3)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage

LM709/LM709A/LM709C ± 18V

Power Dissipation (Note 1)

LM709/LM709A 300 mW LM709C 250 mW

Differential Input Voltage

LM709/LM709A/LM709C ±5V

Input Voltage

LM709/LM709A/LM709C ±10V

Output Short-Circuit Duration ($T_A = +25$ °C)

LM709/LM709A/LM709C 5 seconds

Operating Ratings (Note 3)

Junction Temperature Range (Note 1)

Thermal Resistance (θ_{JA})

H Package 150°C/W, $(\theta_{\rm JC})$ 45°C/W 8-Pin N Package 134°C/W 14-Pin N Package 109°C/W

Electrical Characteristics (Note 2)

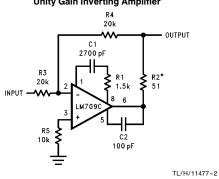
| Davamatav | Conditions | | LM709A | | | LM709 | | | LM709C | | | |
|---|--|--|------------|--------------------------|----------------------|------------|------------|------------|------------|--------------|------------|---------|
| Parameter | | | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Units |
| Input Offset Voltage | $T_{A}=$ 25°C, $R_{S}\leq$ 10 k Ω | | | 0.6 | 2.0 | | 1.0 | 5.0 | | 2.0 | 7.5 | mV |
| Input Bias Current | $T_A = 25^{\circ}C$ | | | 100 | 200 | | 200 | 500 | | 300 | 1500 | nA |
| Input Offset Current | $T_A = 25^{\circ}C$ | | | 10 | 50 | | 50 | 200 | | 100 | 500 | nA |
| Input Resistance | $T_A = 25^{\circ}C$ | | 350 | 700 | | 150 | 400 | | 50 | 250 | | kΩ |
| Output Resistance | $T_A = 25^{\circ}C$ | | | 150 | | | 150 | | | 150 | | Ω |
| Supply Current | $T_A = 25^{\circ}C, V_S = \pm 15V$ | | | 2.5 | 3.6 | | 2.6 | 5.5 | | 2.6 | 6.6 | mA |
| Transient Response Risetime Overshoot | $V_{IN} = 20 \text{ mV}, C$ $T_A = 25^{\circ}\text{C}$ | $C_{L} \leq 100 pF$ | | | 1.5 30 | | 0.3 10 | 1.0 30 | | 0.3 10 | 1.0 30 | μs % |
| Slew Rate | T _A = 25°C | | | 0.25 | | | 0.25 | | | 0.25 | | V/μs |
| Input Offset Voltage | $R_S \leq 10 \ k\Omega$ | | | | 3.0 | | | 6.0 | | | 10 | mV |
| Average Temperature Coefficient of Input Offset Voltage | $R_S = 50\Omega$ $R_S = 10 \text{ k}\Omega$ | $T_A = 25^{\circ}\text{C to T}_{\text{MAX}}$ $T_A = 25^{\circ}\text{C to T}_{\text{MIN}}$ $T_A = 25^{\circ}\text{C to T}_{\text{MAX}}$ $T_A = 25^{\circ}\text{C to T}_{\text{MIN}}$ | | 1.8 1.8 2.0 4.8 | 10 10 15 25 | | 3.0 6.0 | | | 6.0 12 | | μV/°C |
| Large Signal Voltage Gain | $V_S=\pm 15 V, R_L \geq 2 k \Omega$ $V_{OUT}=\pm 10 V$ | | 25 | | 70 | 25 | 45 | 70 | 15 | 45 | | V/mV |
| Output Voltage Swing | $\begin{aligned} &V_S=\pm15V,R_L=10k\Omega\\ &V_S=\pm15V,R_L=2k\Omega \end{aligned}$ | | ±12 ±10 | ±14 ±13 | | ±12 ±10 | ±14 ±13 | | ±12 ±10 | ± 14 ± 13 | | V |
| Input Voltage Range | $V_S = \pm 15V$ | | ±8 | | | ±8 | ±10 | | ±8 | ±10 | | V |
| Common-Mode Rejection Ratio | $R_S \le 10 \text{ k}\Omega$ | | 80 | 110 | | 70 | 90 | | 65 | 90 | | dB |
| Supply Voltage Rejection Ratio | $R_S \le 10 \text{ k}\Omega$ | | | 40 | 100 | | 25 | 150 | | 25 | 200 | μV/V |
| Input Offset Current | $\begin{aligned} T_{A} &= T_{MAX} \\ T_{A} &= T_{MIN} \end{aligned}$ | | | 3.5 40 | 50 250 | | 20 100 | 200 500 | | 75 125 | 400 750 | nA |
| Input Bias Current | $T_A = T_{MIN}$ | | | 0.3 | 0.6 | | 0.5 | 1.5 | | 0.36 | 2.0 | μΑ |
| Input Resistance | $T_A = T_{MIN}$ | | 85 | 170 | | 40 | 100 | | 50 | 250 | | kΩ |

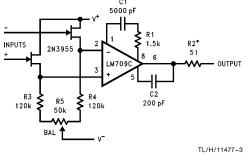
Note 1: For operating at elevated temperatures, the device must be derated based on a 150°C maximum junction temperature for LM709/LM709A and 100°C maximum for L709C. For operating at elevated temperatures, the device must be derated based on thermal resistance θ_{JA} , $T_{J(MAX)}$ and T_A .

Note 2: These specifications apply for $-55^{\circ}\text{C} \le T_A \le +125^{\circ}\text{C}$ for the LM709/LM709A and $0^{\circ}\text{C} \le T_A \le +70^{\circ}\text{C}$ for the LM709C with the following conditions: $\pm 9V \le V_S \le \pm 15V$, C1 = 5000 pF, R1 = $1.5 \text{ k}\Omega$, C2 = 200 pF and R2 = 51Ω .

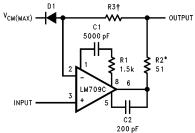
Note 3: Absolute Maximum Ratings indicate limits which if exceeded may result in damage. Operating Ratings are conditions where the device is expected to be functional but not necessarily within the guaranteed performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics.

Schematic Diagram** INPUT FREQUENCY COMPENSATION 1 (A) R6 10k R2 25k - оитрит ₹ R9 09 5 OUTPUT FREQUENCY COMPENSATION INPUTS + 3 Q1 012 Q10 TL/H/11477-1 Typical Applications** Unity Gain Inverting Amplifier **FET Operational Amplifier** R4 20k C1 5000 pF OUTPUT



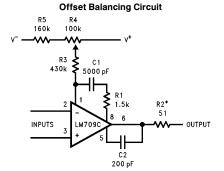






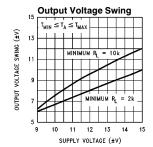
*To be used with any capacitive loading on output.

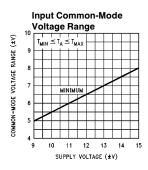
**Pin connections shown are for metal can package. †Should be equal to DC source resistance on input.

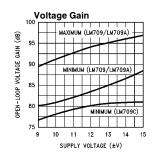


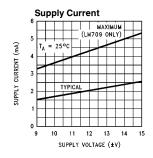
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Guaranteed Performance Characteristics



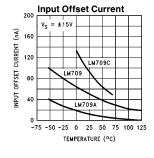


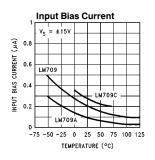


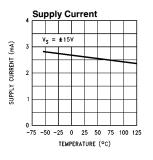


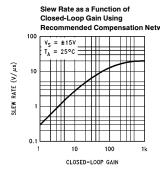
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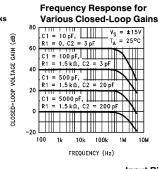


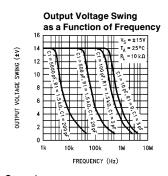


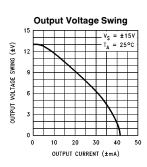


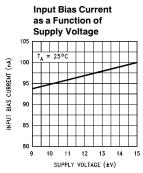




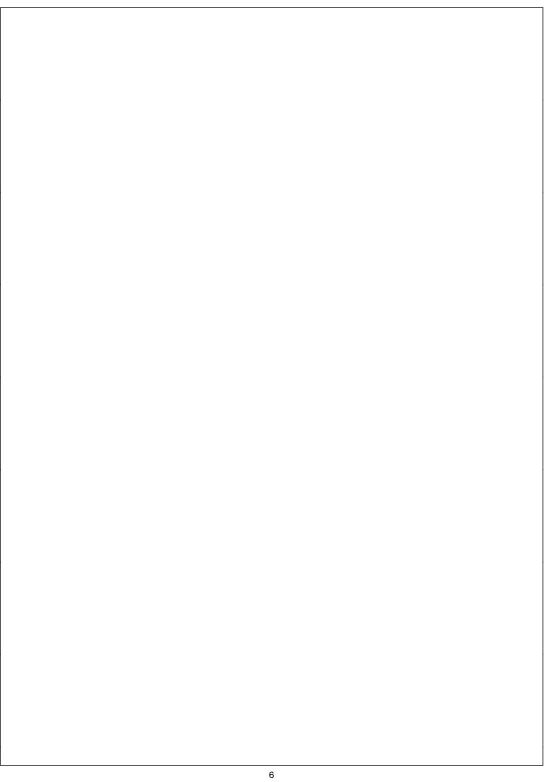


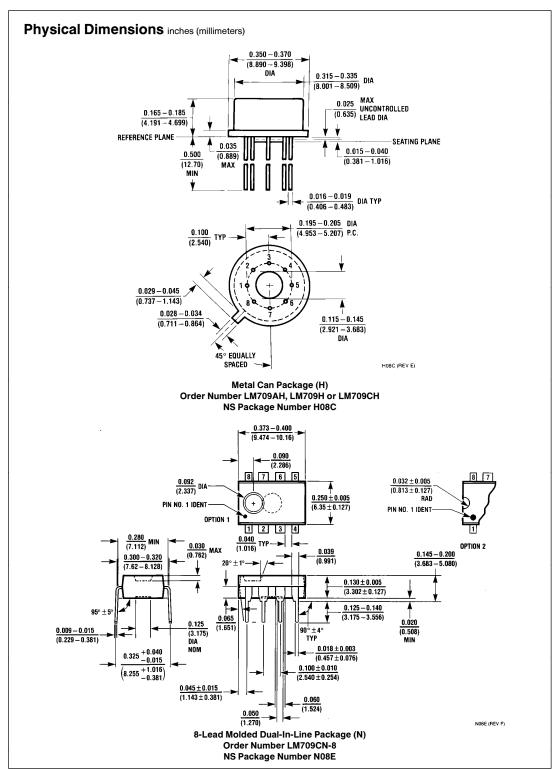




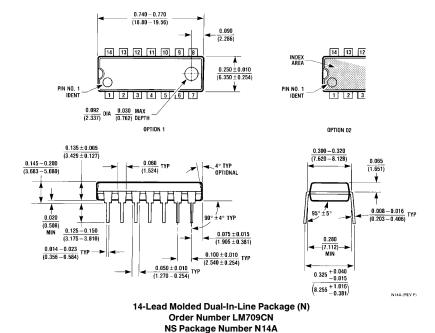


TL/H/11477-10





Physical Dimensions inches (millimeters) (Continued)



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